

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of

Atty Dkt. 2826-9

HONG et al.

C# M#

Serial No. 10/047,119

C/A.U.

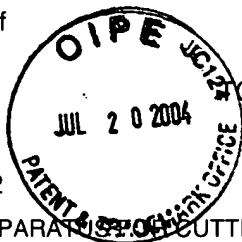
1725

Filed: January 17, 2002

Examiner: Evans, G.

Date: July 20, 2004

Title: METHOD AND APPARATUS FOR CUTTING A MULTI-LAYER SUBSTRATE BY DUAL LASER IRRADIATION



Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

RESPONSE/AMENDMENT/LETTER

This is a response/amendment/letter in the above-identified application and includes an attachment which is hereby incorporated by reference and the signature below serves as the signature to the attachment in the absence of any other signature thereon.

☐ **Correspondence Address Indication Form Attached.**

Fees are attached as calculated below:

Total effective claims after amendment	24	minus highest number			
previously paid for	21	(at least 20) =	3	x	\$ 18.00
					\$ 54.00

Independent claims after amendment	3	minus highest number			
previously paid for	3	(at least 3) =	0	x	\$ 86.00
					\$ 0.00

If proper multiple dependent claims now added for first time, add \$290.00 (ignore improper)	\$ 0.00
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Petition is hereby made to extend the current due date so as to cover the filing date of this paper and attachment(s) (\$110.00/1 month; \$420.00/2 months; \$950.00/3 months)	\$ 0.00
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Terminal disclaimer enclosed, add \$ 110.00	\$ 0.00
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<input type="checkbox"/> First/second submission after Final Rejection pursuant to 37 CFR 1.129(a) (\$770.00)	\$ 0.00
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☐ Please enter the previously unentered , filed

☐ Submission attached

Subtotal \$ 54.00

If "small entity," then enter half (1/2) of subtotal and subtract	-\$ 0.00
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☐ Applicant claims "small entity" status. ☐ Statement filed herewith

Rule 56 Information Disclosure Statement Filing Fee (\$180.00)	\$ 0.00
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Assignment Recording Fee (\$40.00)	\$ 0.00
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Other:	0.00
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TOTAL FEE ENCLOSED \$ 54.00

The Commissioner is hereby authorized to charge any deficiency, or credit any overpayment, in the fee(s) filed, or asserted to be filed, or which should have been filed herewith (or with any paper hereafter filed in this application by this firm) to our Account No. 14-1140. A duplicate copy of this sheet is attached.

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By Atty: John R. Lastova, Reg. No. 33,149

Signature:



1725-25W
/

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of

HONG et al.

Atty. Ref.: 2826-9; Confirmation No.

Appl. No. 10/047,119

TC/A.U. 1725

Filed: January 17, 2002

Examiner: Evans, G.

For: METHOD AND APPARATUS FOR CUTTING A MULTI-LAYER SUBSTRATE
BY DUAL LASER IRRADIATION

* * * * *

July 20, 2004

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

AMENDMENT

In response to the Official Action dated April 20, 2004, please amend the
above-identified application as follows:

07/21/2004 EFLDRES 00000104 10047119

01 FC:1202

54.00 OP